

LNPTM STAT-KONTM COMPOUND RD0001

R-HI REGION AMERICAS

DESCRIPTION

LNP STAT-KON RD000I compound is based on Nylon 6/6 resin containing conductive carbon powder. Added features of this grade include: Electrically Conductive, High Impact.

GENERAL INFORMATION	
Features	Electrically Conductive, Impact resistant, No PFAS intentionally added
Fillers	Carbon Powder
Polymer Types	Polyamide 66 (Nylon 66)
Processing Techniques	Injection Molding

INDUSTRY	SUB INDUSTRY
Electrical and Electronics	Electronic Components
Industrial	Material Handling

TYPICAL PROPERTY VALUES

PROPERTIES UNITS **TEST METHODS TYPICAL VALUES** MECHANICAL⁽¹⁾ Tensile Stress, brk, Type I, 5 mm/min 41 MPa ASTM D638 Tensile Strain, brk, Type I, 5 mm/min 18 % ASTM D638 Tensile Modulus, 50 mm/min 2120 MPa ASTM D638 Flexural Modulus, 1.3 mm/min, 50 mm span 1920 MPa ASTM D790 ISO 527 Tensile Stress, break, 5 mm/min 41 MPa Tensile Strain, break, 5 mm/min 18 % ISO 527 2190 Tensile Modulus, 1 mm/min MPa ISO 527 ISO 178 Flexural Stress 62 MPa 2020 ISO 178 Flexural Modulus, 2 mm/min MPa IMPACT (1) Izod Impact, unnotched, 23°C 1810 J/m ASTM D4812 Izod Impact, notched, 23°C 150 J/m ASTM D256 20 ISO 6603 Multiaxial Impact I Instrumented Dart Impact Total Energy, 23°C 16 ASTM D3763 I ISO 180/1U Izod Impact, unnotched 80*10*4 +23°C 155 kJ/m² Izod Impact, notched 80*10*4 +23°C 14 kJ/m² ISO 180/1A THERMAL (1) °C HDT, 0.45 MPa, 3.2 mm, unannealed 206 ASTM D648 °C HDT, 1.82 MPa, 3.2mm, unannealed 73 ASTM D648 CTE, -30°C to 30°C, flow 1.1F-04 1/°C ASTM D696 CTE, -30°C to 30°C, xflow 1.2E-04 1/°C ASTM D696

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CHEMISTRY THAT MATTERS

Revision 20241028



PROPERTIES	TYPICAL VALUES	UNITS	TEST METHODS
Thermal Conductivity	2.8	W/m-°C	ASTM E1530
HDT/Bf, 0.45 MPa Flatw 80*10*4 sp=64mm	191	°C	ISO 75/Bf
HDT/Af, 1.8 MPa Flatw 80*10*4 sp=64mm	68	°C	ISO 75/Af
PHYSICAL ⁽¹⁾			
Specific Gravity	1.15	-	ASTM D792
Moisture Absorption, (23°C/50% RH/24 hrs)	0.49	%	ASTM D570
Mold Shrinkage, flow, 24 hrs ⁽²⁾	2 – 4	%	ASTM D955
Mold Shrinkage, xflow, 24 hrs ⁽²⁾	2 – 4	%	ASTM D955
Density	1.15	g/cm ³	ISO 1183
Moisture Absorption (23°C / 50% RH)	0.73	%	ISO 62
ELECTRICAL ⁽¹⁾			
Surface Resistivity ⁽³⁾	1.E+01 – 1.E+06	Ω	ASTM D257
INJECTION MOLDING (4)			
Drying Temperature	80	°C	
Drying Time	4	Hrs	
Maximum Moisture Content	0.15 – 0.25	%	
Melt Temperature	280 – 305	°C	
Front - Zone 3 Temperature	295 – 305	°C	
Middle - Zone 2 Temperature	280 – 295	°C	
Rear - Zone 1 Temperature	265 – 275	°C	
Mold Temperature	95 – 110	°C	
Back Pressure	0.2 – 0.3	MPa	
Screw Speed	30 – 60	rpm	

(1) The information stated on Technical Datasheets should be used as indicative only for material selection purposes and not be utilized as specification or used for part or tool design.

(2) Measurements made from laboratory test coupon. Actual shrinkage may vary outside of range due to differences in processing conditions, equipment, part geometry and tool design. It is recommended that mold shrinkage studies be performed with surrogate or legacy tooling prior to cutting tools for new molded article.

(3) Measurement meets requirements as specified in ASTM D4496.

(4) Injection Molding parameters are only mentioned as general guidelines. These may not apply or may need adjustment in specific situations such as low shot sizes, large part molding, thin wall molding and gas-assist molding.

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